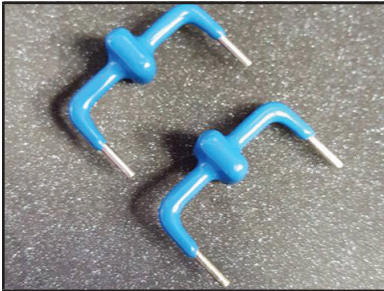


## HIGH POWERED TVS COMPONENT



**AXIAL LEAD**

### APPLICATIONS

- DC & AC Applications
- Remote Transmission Lines
- Industrial Wiring

Bidirectional



### FEATURES

- UL Registered
- Axial Lead Terminals
- High Current Capability
- Excellent Clamping Voltage
- Glass Passivated Junction
- Bidirectional Configuration
- Low Slope Resistance
- Repetition Rate (Duty Cycle): 0.01%
- Hazardous Substance Free
- RoHS Complaint (Exemption #7)

### MECHANICAL CHARACTERISTICS

- Epoxy Encapsulated Axial Lead Device
- Approximate Weight: 3.35 grams
- High Temperature Soldering: 260°C / 10 seconds at Terminals
- Flammability Rating UL 94V-0
- Marking: Part Number

#### MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Operating Temperature	$T_J$	-55 to 125	°C
Storage Temperature	$T_{STG}$	-55 to 150	°C
KA Series - Current Rating, Rated $I_{PP}$ @ 8/20 $\mu$ s	$I_{PP}$	3	kA
KB Series - Current Rating, Rated $I_{PP}$ @ 8/20 $\mu$ s	$I_{PP}$	6	kA
KC Series - Current Rating, Rated $I_{PP}$ @ 8/20 $\mu$ s	$I_{PP}$	10	kA
K1 Series - Current Rating, Rated $I_{PP}$ @ 8/20 $\mu$ s	$I_{PP}$	1	kA
KD Series - Current Rating, Rated $I_{PP}$ @ 8/20 $\mu$ s	$I_{PP}$	15	kA

## TYPICAL DEVICE CHARACTERISTICS

## ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER (Note 1)	REVERSE STAND-OFF VOLTAGE		MINIMUM BREAKDOWN VOLTAGE  $V_{(BR)} @ I_T$ VOLTS	TEST CURRENT  $@ I_T$ mA	CURRENT RATING  8/20 $\mu$ s kA	MAXIMUM CLAMPING VOLTAGE  $@ I_{PP}$ $V_C$ VOLTS	REVERSE LEAKAGE CURRENT  $@ V_{DC}$ $I_R$ $\mu$ A
	$V_{AC}$ VOLTS	$V_{DC}$ VOLTS					
K1-076	54.0	76.0	83.0	10	1	135.0	20
K1-380	275.0	380.0	401.0	10	1	520.0	10
K1-430	310.0	430.0	440.0	10	1	625.0	10
KA-058*	40.0	58.0	64.0	10	3	110.0	20
KA-076*	54.0	76.0	85.0	10	3	140.0	20
KA-150	106.0	150.0	158.0	10	3	230.0	10
KA-170	130.0	170.0	179.0	10	3	260.0	10
KA-275	194.0	275.0	300.0	10	3	435.0	10
KA-380*	275.0	380.0	401.0	10	3	520.0	20
KA-430*	310.0	430.0	440.0	10	3	652.0	20
KB-058*	40.0	58.0	64.0	10	6	110.0	20
KB-076*	54.0	76.0	83.0	10	6	135.0	20
KB-170*	130.0	170.0	180.0	10	6	260.0	20
KB-190*	145.0	190.0	200.0	10	6	290.0	20
KB-240*	180.0	240.0	250.0	10	6	340.0	20
KB-275	194.0	275.0	300.0	10	6	435.0	10
KB-380*	275.0	380.0	401.0	10	6	520.0	20
KB-430*	310.0	430.0	440.0	10	6	625.0	20
KC-058	40.0	58.0	64.0	10	10	110.0	20
KC-076*	54.0	76.0	83.0	10	10	135.0	20
KC-170	130.0	170.0	180.0	10	10	260.0	20
KC-190*	145.0	190.0	200.0	10	10	290.0	20
KC-200*	150.0	200.0	222.0	10	10	330.0	20
KC-240	180.0	240.0	250.0	10	10	340.0	20
KC-250	188.0	250.0	261.0	10	10	370.0	20
KC-275	194.0	275.0	300	10	10	435.0	10
KC-380*	275.0	380.0	401.0	10	10	520.0	20
KC-430*	310.0	430.0	440.0	10	10	625.0	20
KD-058	40.0	58.0	64.0	10	15	110.0	20
KD-076	54.0	76.0	85.0	10	15	145.0	20

## NOTE

1. \*Contact factory for minimum order quantities.

**TYPICAL DEVICE CHARACTERISTICS**
**TABLE 1 - STANDARD PACKAGE , LEADED PROCESS, PACKAGE PEAK REFLOW TEMPERATURE**

Package Thickness	Volume mm <sup>3</sup> < 350	Volume mm <sup>3</sup> >= 350
< 2.5mm	240 +0/-5°C	225 +0/-5°C
>= 2.5mm	225 +0/-5°C	225 +0/-5°C

**NOTES:**

1. The package thickness and volume dictates the maximum component temperature. The thermal gradients between packages can be reduced by using convection reflow processes.
2. Volume of the package does not account for the external terminals.
3. Package volume is the equivalent of package size multiplied by the height.

**TABLE 2 - LEAD-FREE PROCESS, PACKAGE PEAK REFLOW TEMPERATURE**

Package Thickness	Volume mm <sup>3</sup> < 350	Volume mm <sup>3</sup> 250 - 2000	Volume mm <sup>3</sup> > 2000
< 1.6mm	260 +0°C	260 +0°C	260 +0°C
1.6mm - 2.5mm	260 +0°C	250 +0°C	245 +0°C
>= 2.5mm	250 +0°C	245 +0°C	245 +0°C

**NOTES:**

1. The profiling tolerance is +0, -X °C but at no time will it exceed -5°C.
2. Volume of the package does not account for the external terminals.
3. The package thickness and volume dictates the maximum component temperature. The thermal gradients between packages can be reduced by using convection reflow processes.
4. Components used in lead-free assembly shall be evaluated using the lead-free classification temperature and profiles as defined in the above table.
5. Table 3 will help determine if the components are lead-free or not.
6. The device manufacturer/supplier shall ensure process compatibility up to and including the stated classification temperature at the rated MSL level.

**TABLE 3 - CLASSIFICATION REFLOW PROFILES**

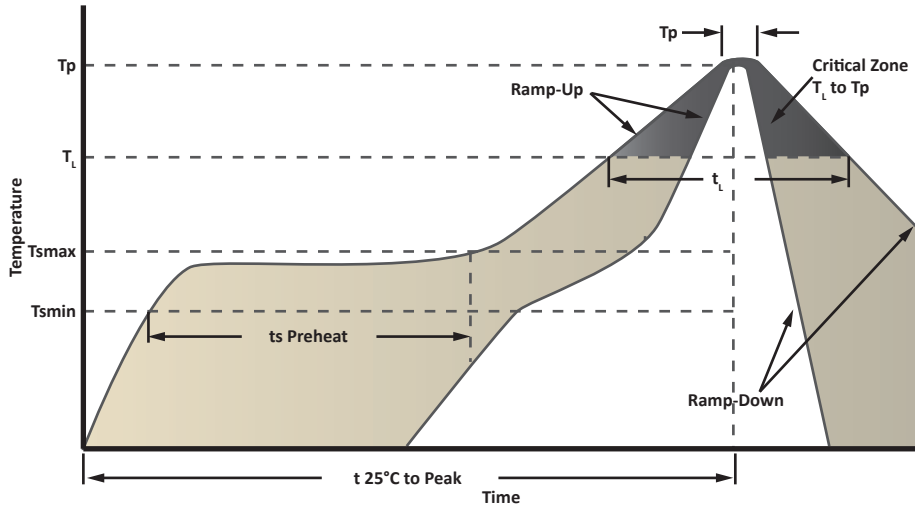
Profile Feature	Sn - Pb Eutectic Assembly	Pb-Free Assembly
Average Ramp Up Rate ( $T_{SMAX}$ to $T_p$ )	3°C/seconds Max.	3°C/seconds Max.
Preheat Temperature Min $T_{SMIN}$ Temperature MAX $T_{SMAX}$ Time ( $T_{SMIN}$ to $T_{SMAX}$ ) (ts)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time Maintained Above Temperature ( $T_L$ ) Time( $t_L$ )	183°C 60-150 seconds	217°C 60-150 seconds
Peak/Classification Temperature ( $T_p$ )	See Table 1	See Table 2
Time Within 5°C of Actual Temperature ( $t_p$ )	10-30 seconds	20-40 seconds
Ramp-Down Rate	6°C/seconds Max.	6°C/seconds Max.
Time 25°C to Peak Temperature	6 Minutes Max.	8 Minutes Max.

**NOTES:**

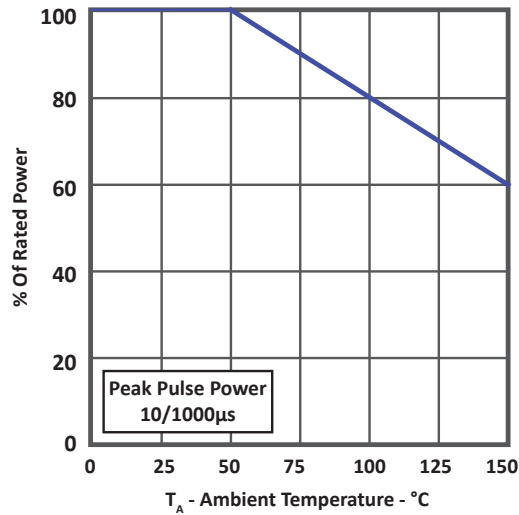
1. All temperatures refer to topside of the package, measured on the package body surface.
2. Time within 5°C of the actual peak temperature ( $T_p$ ) specified for the reflow profiles is "supplier" minimum and "user" maximum.

**TYPICAL DEVICE CHARACTERISTICS**

**FIGURE 1  
SOLDER WAVEFORM**

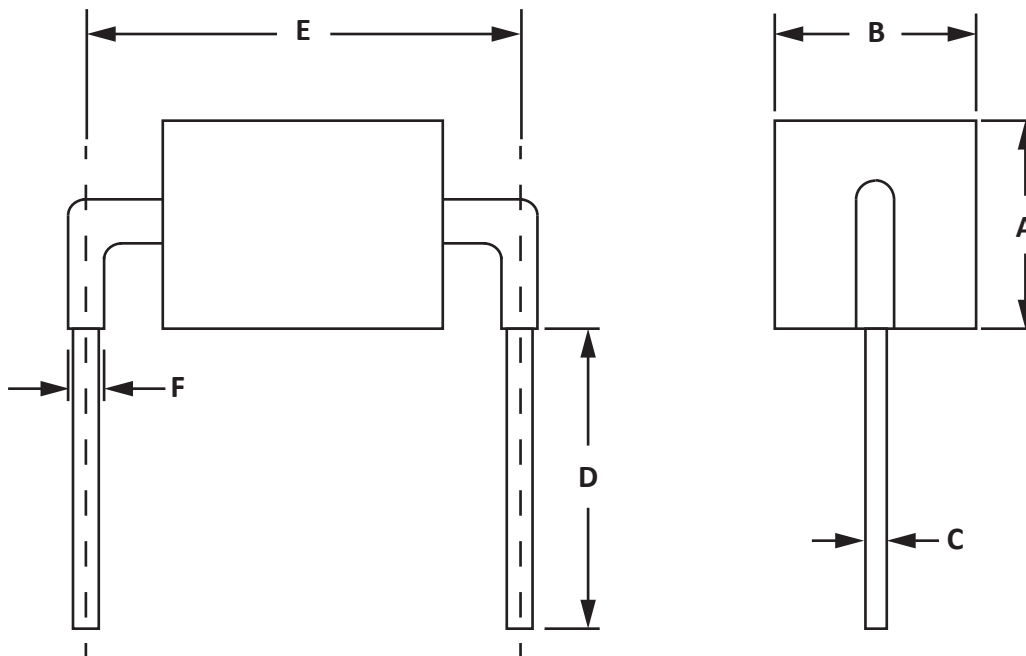


**FIGURE 2  
POWER DERATING CURVE**



**AXIAL LEAD PACKAGE INFORMATION**

OUTLINE DIMENSIONS				
DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	-	14.5	-	0.57
B	-	12.7	-	0.50
C	1.28	1.32	0.050	0.052
D	5.0	7.0	0.20	0.28
E	23.45	24.85	0.92	0.98
F	-	2.5	-	0.10



## COMPANY INFORMATION

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### COMPANY PROFILE

In business more than 25 years, ProTek Devices™ is a privately held semiconductor company. The company offers a product line of overvoltage protection and overcurrent protection components. These include transient voltage suppressor array (TVS arrays) avalanche breakdown diode, steering diode TVS array and electronics SMD chip fuses. These components deliver circuit protection in electronic systems from numerous overvoltage and overcurrent events. They include lightning; electrostatic discharge (ESD); nuclear electromagnetic pulses (NEMP); inductive switching; and electromagnetic interference (EMI) / radio frequency interference (RFI). ProTek Devices also offers LED wafer die for ESD protection and related high frequency products. ProTek Devices is an ISO 9001 certified company.

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